

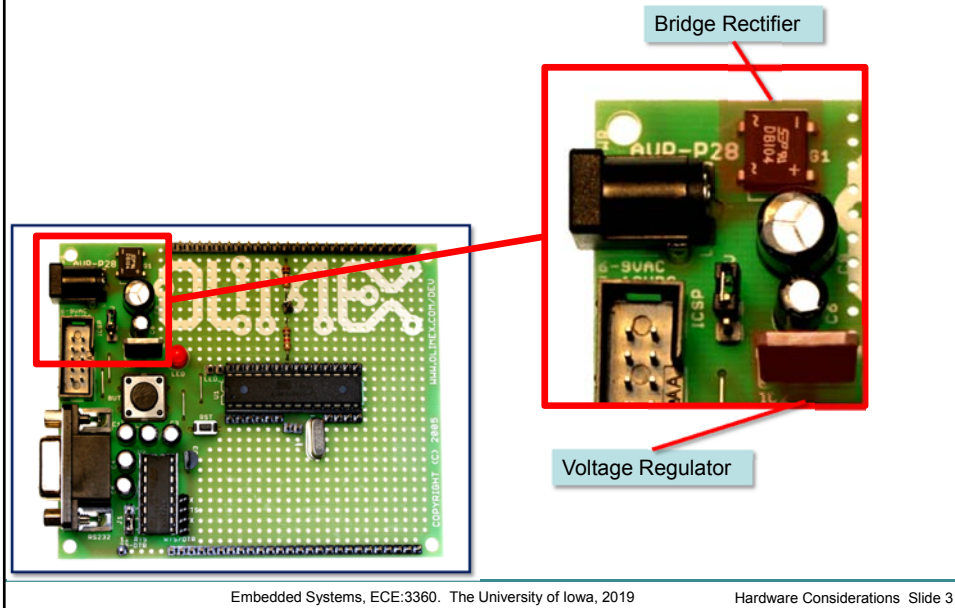
# *Embedded Systems*

## **Some Hardware Considerations**



## *Power Supplies*

## Power Supplies

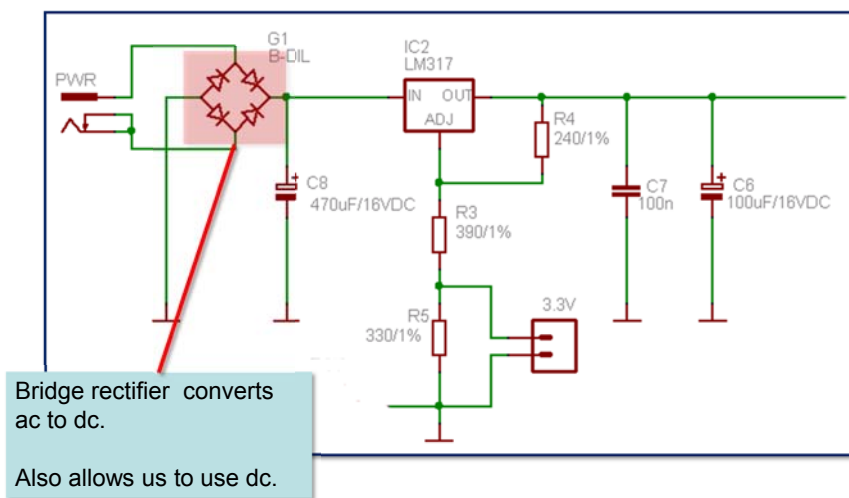


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Hardware Considerations Slide 3

## Power Supplies

Power supply section from 28-pin development board

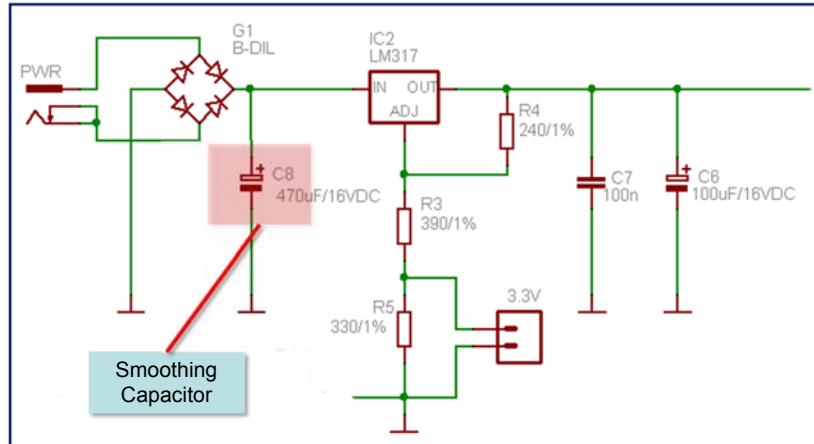


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Hardware Considerations Slide 4

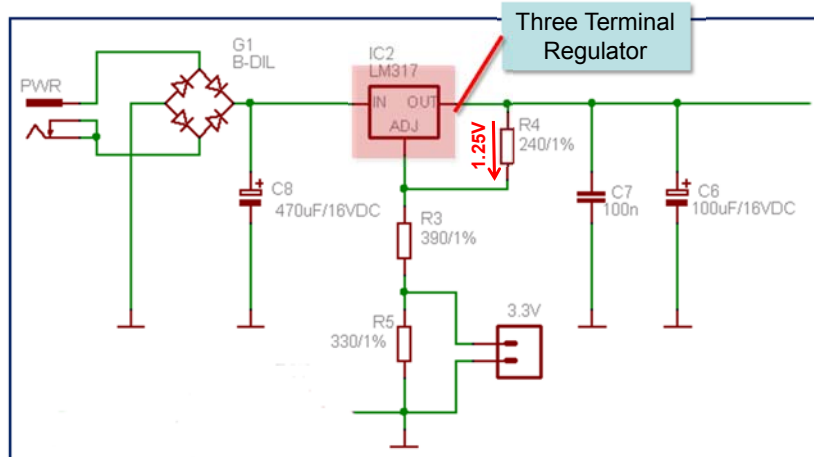
## Power Supplies

Power supply section from 28-pin development board



## Power Supplies

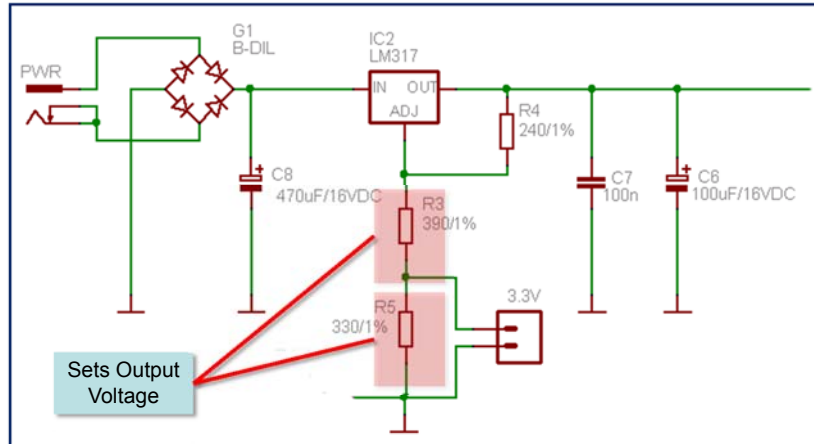
Power supply section from 28-pin development board



$$I_{adj} \sim 50\mu A$$

## Power Supplies

Power supply section from 28-pin development board

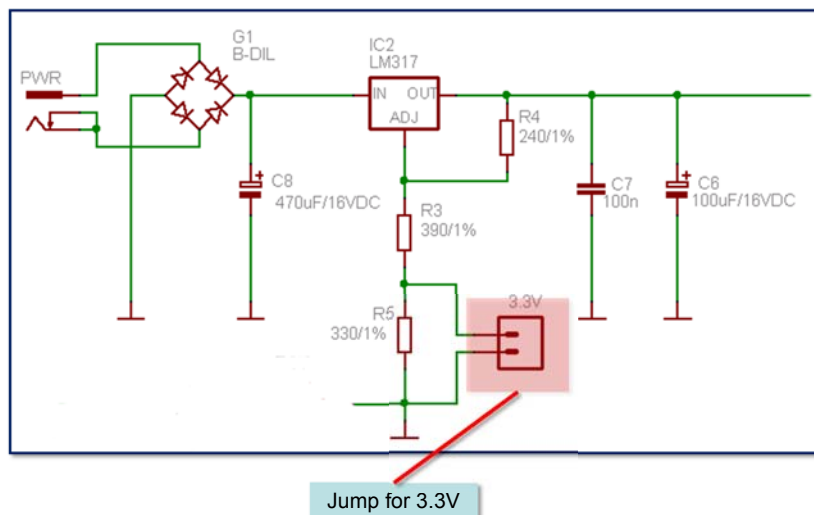


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Hardware Considerations Slide 7

## Power Supplies

Power supply section from 28-pin development board

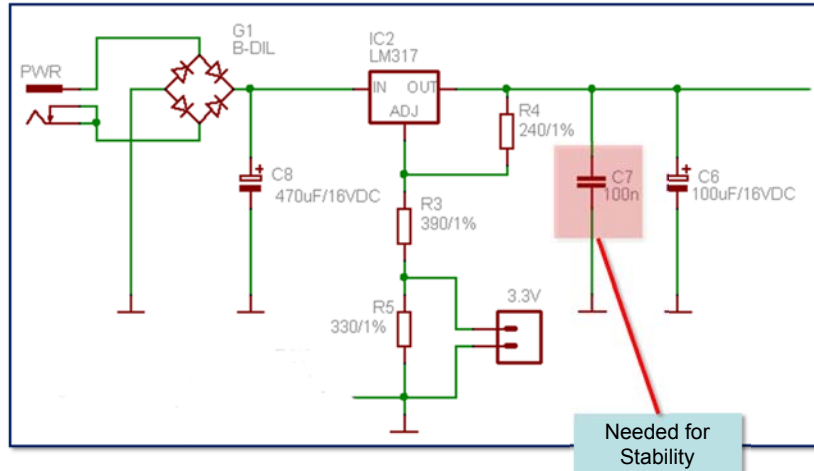


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## Power Supplies

Power supply section from 28-pin development board

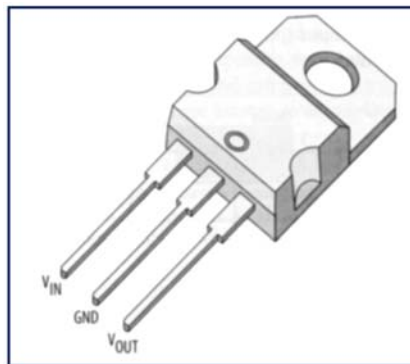


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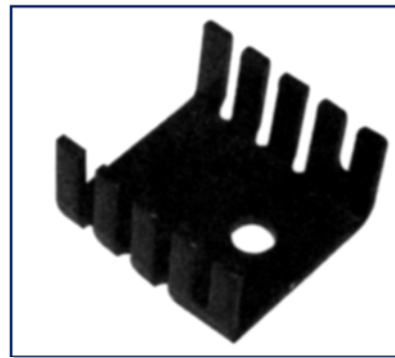
Hardware Considerations Slide 9

## Power Supplies

Linear Three-Terminal Regulator



LM78XX Three-terminal regulator pinout in TO220 package



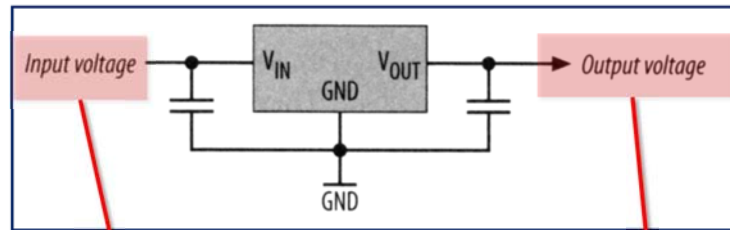
Heat sink to cool down regulator

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Hardware Considerations Slide 10

## Power Supplies

### Linear Three-Terminal Regulator



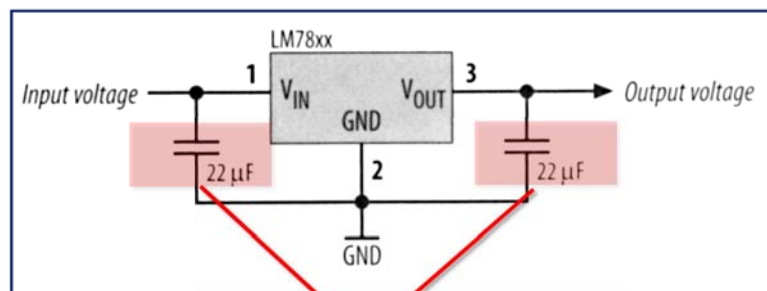
Varying input voltage, say 7-14 V. Must be larger than output voltage + some headroom, typically 1-2 V

Constant voltage: 3 V, 5 V, etc.

**Note that linear regulators cannot step up a voltage, but can regulate it down.**

## Power Supplies

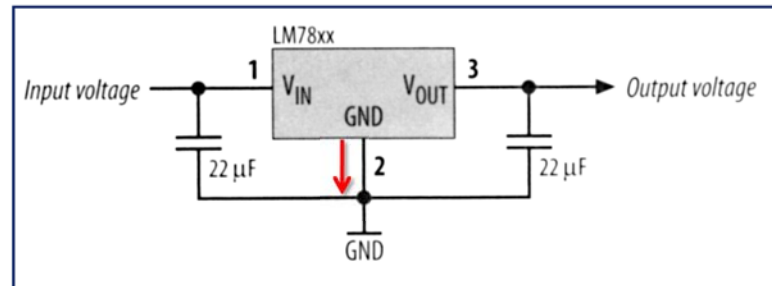
### Linear Three-Terminal Regulator



These capacitors are easily-overlooked but a crucial for proper operation

## Power Supplies

### Linear Three-Terminal Regulator



Quiescent current for LM78xx regulators are large, and can waste lots of energy → not suitable for battery-operated equipment.

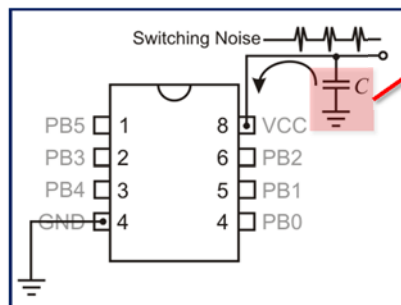
## Decoupling Capacitors

Consider a microcontroller that runs on a 10 MHz clock. This means the clock period is 100 ns. The rise and fall time of the clock is thus on the order of 10 ns or shorter.

The microcontroller's internal electronics (logic gates) create significant switching noise that appears on the power supply lines.

The current is drawn in very short spikes on the clock edges. If I/O lines are switching, the spikes will be even higher.

This kind of current spike cannot be delivered over long power supply lines; the main source is (or should be) the **decoupling capacitor**.



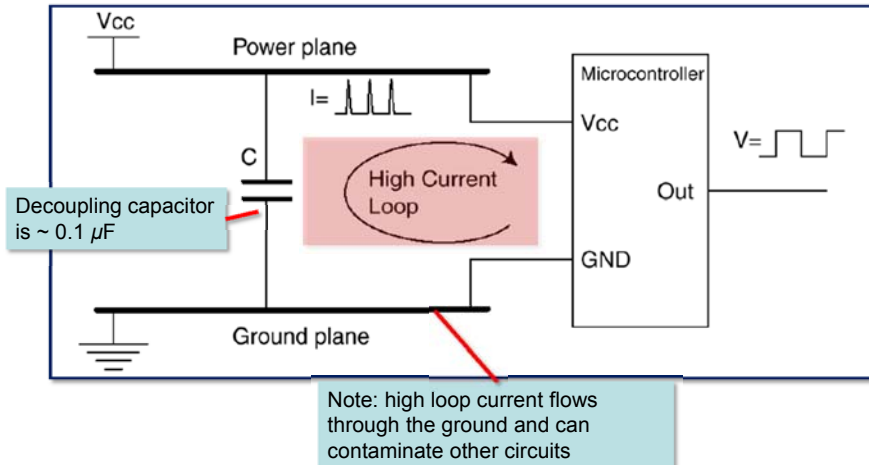
Decoupling capacitor  
~ 0.1  $\mu\text{F}$

Used properly, a decoupling capacitor can greatly reduce switching noise.

Sometimes called a **bypass capacitor**

## Power Supply Decoupling

### Wrong way to decouple power supply

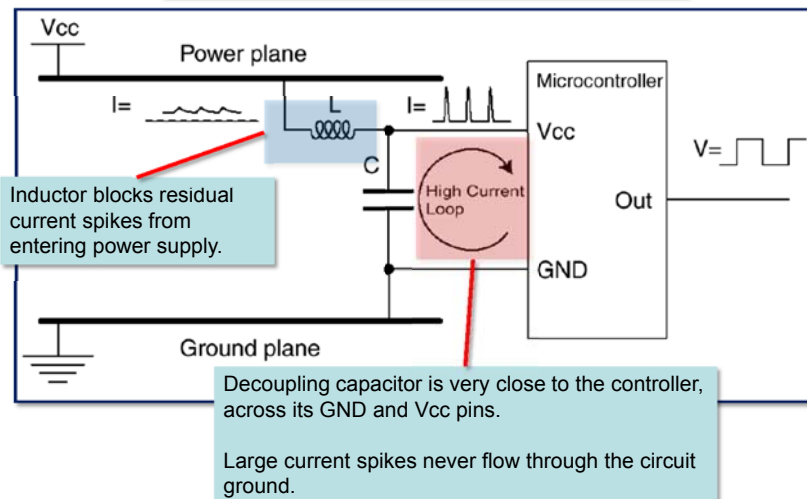


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Hardware Considerations Slide 15

## Power Supply Decoupling

### Better way to decouple power supply



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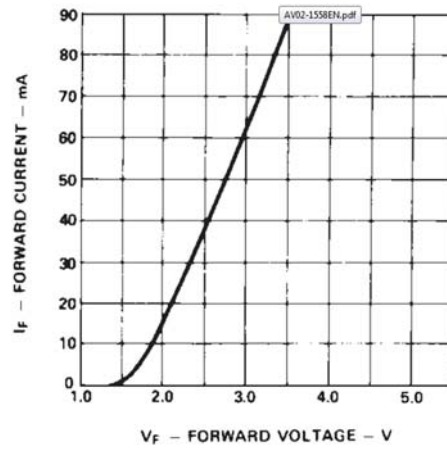
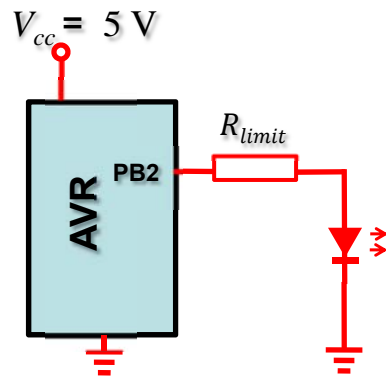


## *Controlling a (high power) load with a Microcontroller*

## *Controlling high power loads with Microcontrollers*

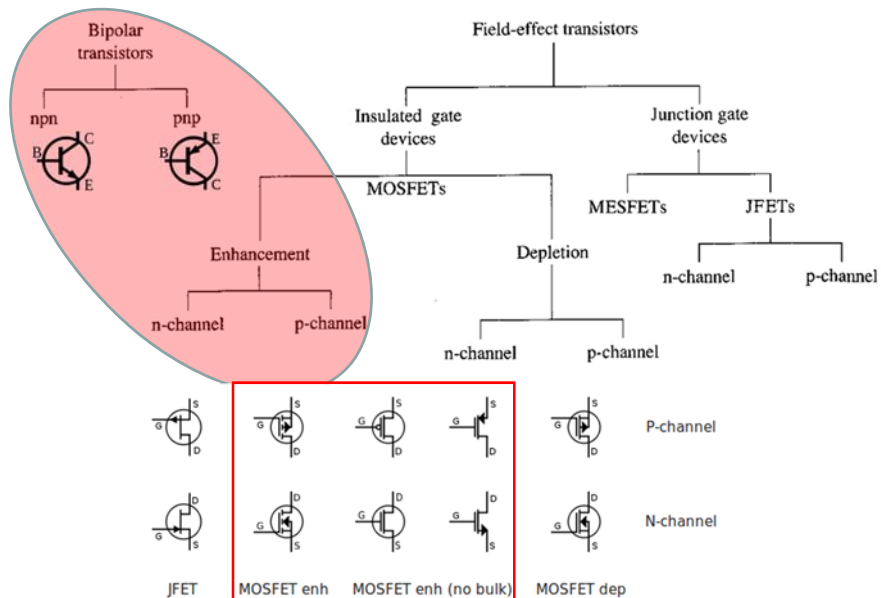
- Often it is necessary to control (switch on & off) loads with a  $\mu\text{C}$
- Examples are:
  - Lamps or Power LEDs
  - Electro motors or stepper motors
  - Heating elements
  - Solenoids
  - GPS receiver
  - Etc.
- $\mu\text{C}$  output buffers have limits:
  - ATmega88PA – Absolute Maximum Ratings:
    - DC current per I/O pin: 40 mA
    - DC current Vcc and GND pins: 200 mA
- Requirements can exceed these limits
  - E.g., motor with 300 mA @ 12 V, 120 Vac heating element, ...
- → Use (power) transistors, relays (mechanical & solid state), etc.

## Driving an LED

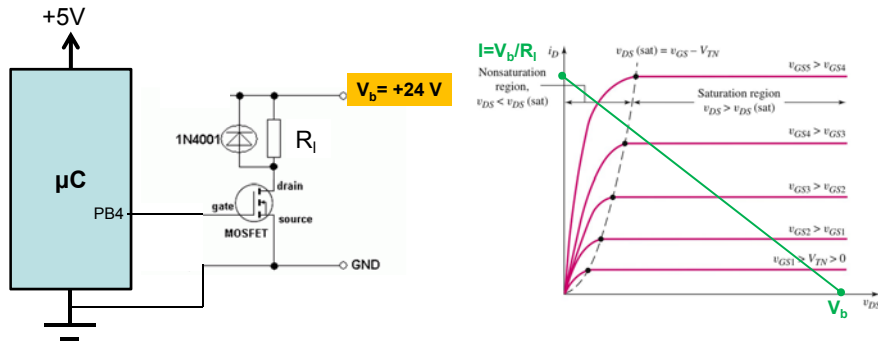


Use the LED's V-I characteristics from its datasheet to determine the forward voltage for a given current. Then apply Ohm's Law to determine  $R_{limit}$ .

## Overview - Transistors



## Using a N-MOSFET (Enhancement) as Switch



MOSFET selection: make sure that  $V_{GSth}$  ( $V_{TN}$ ) is suitable for logic levels!

## Logic Level Power MOSFET

**FAIRCHILD**  
SEMICONDUCTOR®

RFP30N06LE, RF1S30N06LESM

Data Sheet

January 2004

### 30A, 60V, ESD Rated, 0.047 Ohm, Logic Level N-Channel Power MOSFETs

These are N-Channel power MOSFETs manufactured using the MegaFET process. This process, which uses feature sizes approaching those of LSI integrated circuits gives optimum utilization of silicon, resulting in outstanding performance. They were designed for use in applications such as switching regulators, switching converters, motor drivers and relay drivers. These transistors can be operated directly from integrated circuits.

These transistors incorporate ESD protection and are designed to withstand 2kV (Human Body Model) of ESD.

Formerly developmental type TA49027.

### Ordering Information

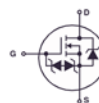
PART NUMBER	PACKAGE	BRAND
RFP30N06LE	TO-220AB	P30N06LE
RF1S30N06LESM	TO-263AB	1S30N06L

NOTE: When ordering use the entire part number. Add suffix, 9A, to obtain the TO-263 variant in tape and reel i.e. RF1S30N06LESM9A.

### Features

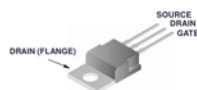
- 30A, 60V
- $r_{DS(ON)} = 0.047\Omega$
- 2kV ESD Protected
- Temperature Compensating PSpice® Model
- Peak Current vs Pulse Width Curve
- UIS Rating Curve
- Related Literature
  - TB334 "Guidelines for Soldering Surface Mount Components to PC Boards"

### Symbol



### Packaging

JEDEC TO-220AB



JEDEC TO-263AB



## Logic Level Power MOSFET

### RFP30N06LE, RF1S30N06LESM

#### Absolute Maximum Ratings $T_A = 25^\circ\text{C}$ , Unless Otherwise Specified

	RFP30N06LE, RF1S30N06LESM	UNITS
Drain to Source Voltage (Note 1).....	$V_{DS}$	60 V
Drain to Gate Voltage ( $R_{GS} = 20\text{k}\Omega$ ) (Note 1).....	$V_{DGR}$	60 V
Gate to Source Voltage.....	$V_{GS}$	+10, -8 V
Continuous Drain Current.....	$I_D$	30 A
Pulsed Drain Current (Note 3).....	$I_{DM}$	Refer to Peak Current Curve
Pulsed Avalanche Rating.....	$E_{AS}$	Refer to UIS Curve
Power Dissipation.....	$P_D$	96 W
Derate Above $25^\circ\text{C}$ .....		0.645 W/ $^\circ\text{C}$
Electrostatic Discharge Rating, MIL-STD-883, Category B(2).....	ESD	2 kV
Operating and Storage Temperature.....	$T_J, T_{STG}$	-55 to 175 $^\circ\text{C}$
Maximum Temperature for Soldering.....	$T_L$	300 $^\circ\text{C}$
Leads at 0.063in (1.6mm) from Case for 10s.....	$T_{pkg}$	260 $^\circ\text{C}$

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

#### NOTE:

1.  $T_J = 25^\circ\text{C}$  to  $150^\circ\text{C}$ .

#### Electrical Specifications $T_C = 25^\circ\text{C}$ , Unless Otherwise Specified

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Drain to Source Breakdown Voltage	$BV_{DS}$	$I_D = 250\mu\text{A}$ , $V_{GS} = 0\text{V}$ , Figure 11	60	-	-	V
Gate to Threshold Voltage	$V_{GS(TH)}$	$V_{DS} = V_{GS}$ , $I_D = 250\mu\text{A}$ , Figure 10	1	-	2	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = \text{Rated } BV_{DS}$ , $V_{GS} = 0$	-	-	25	$\mu\text{A}$
		$V_{DS} = 0.8 \times \text{Rated } BV_{DS}$ , $V_{GS} = 0$ , $T_C = 150^\circ\text{C}$	-	-	250	$\mu\text{A}$
Gate to Source Leakage Current	$I_{GSS}$	$V_{DS} = +10, -8\text{V}$	-	-	$\pm 10$	$\mu\text{A}$
Drain to Source On Resistance (Note 2)	$r_{DS(ON)}$	$I_D = 30\text{A}$ , $V_{GS} = 5\text{V}$ , Figure 9	-	-	0.047	$\Omega$
Turn-On Time	$t_{ON}$	$V_{DD} = 30\text{V}$ , $I_D = 30\text{A}$ , $R_L = 1\Omega$ , $V_{GS} = 5\text{V}$ , $R_{GS} = 2.5\Omega$	-	-	140	ns
Turn-On Delay Time	$t_{S(ON)}$	Figures 13, 16, 17	-	11	-	ns
Rise Time	$t_r$		-	88	-	ns
Turn-Off Delay Time	$t_{S(OFF)}$		-	30	-	ns
Fall Time	$t_f$		-	40	-	ns
Turn-Off Time	$t_{OFF}$		-	-	100	ns

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Hardware Considerations Slide 23

## Driving a (Stepper) Motor

- To control the rotational direction of an electro motor, a drive circuit with bidirectional drive current capability is needed
- This can be accomplished by using a motor driver IC (H-bridge)

TEXAS INSTRUMENTS

L293, L293D

REVISION: SEPTEMBER 1986, REVISED JANUARY 2012

**L293x Quadruple Half-H Drivers**

#### 1 Features

- Wide Supply-Voltage Range: 4.5 V to 36 V
- Separate Input-Logic Supply
- Internal ESD Protection
- High-Noise-Immunity Inputs
- Output Current 1 A Per Channel (600 mA for L293D)
- Peak Output Current 2 A Per Channel (1.2 A for L293D)
- Output Clamp Diodes for Inductive Transient Suppression (L293D)

#### 2 Applications

- Stepper Motor Drivers
- DC Motor Drivers
- Latching Relay Drivers

#### 3 Description

The L293 and L293D devices are quadruple high-current half-H drivers. The L293 is designed to provide bidirectional drive currents of up to 1 A at voltages from 4.5 V to 36 V. The L293D is designed to provide bidirectional drive currents of up to 600-mA at voltages from 4.5 V to 36 V. Both devices are designed to drive inductive loads such as relays, solenoids, DC and bipolar stepping motors, as well as other high-current/high-voltage loads in positive-supply applications.

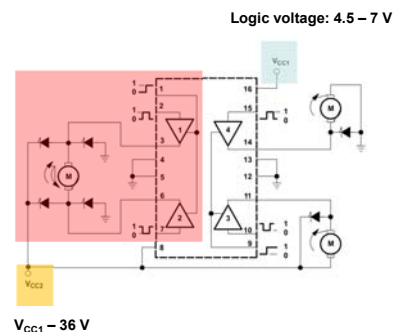
Each output is a complete totem-pole drive circuit, with a Darlington transistor sink and a pseudo-Darlington source. Drivers are enabled in pairs, with drivers 1 and 2 enabled by 1,2EN and drivers 3 and 4 enabled by 3,4EN.

The L293 and L293D are characterized for operation from  $0^\circ\text{C}$  to  $70^\circ\text{C}$ .

**Device Information<sup>(1)</sup>**

PART NUMBER	PACKAGE	BODY SIZE (NOM)
L293NE	POP (16)	19.80 mm × 6.35 mm
L293DNE	POP (16)	19.80 mm × 6.35 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.



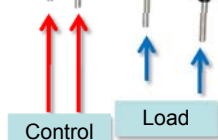
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Hardware Considerations Slide 24

## Driving a High Power Load

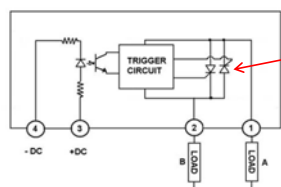
### Solid State Relay (SSR)

- SSR: up to 660 Vac; up to ~75 A
- DC (and AC) control



Description	CX240Dx
Nominal Voltage	5 VDC
Control Voltage Range	3-15 VDC
Minimum Turn-On Voltage	3.0 VDC
Drop Out Voltage	1.0 VDC
Typical Input Current	15 mA <sub>dc</sub>
Nominal Input Impedance	300 Ohm
Maximum Turn-On Time [msec] (3)	1/2 Cycle
Maximum Turn-Off Time [msec]	1/2 Cycle

### GENERAL SPECIFICATIONS



Thyristor

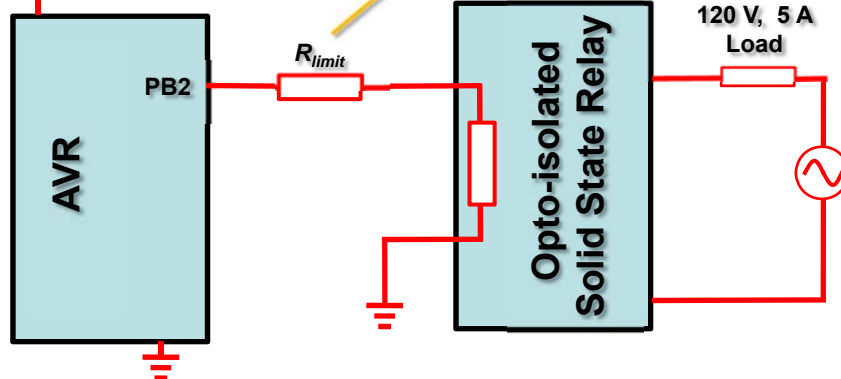
Load can be wired in location A or B

Hardware Considerations Slide 25

## Driving a High-Power External Load

$V_{cc} = 5V$

Depending on the SSR, one may need an external resistor here to limit current out of microcontroller port

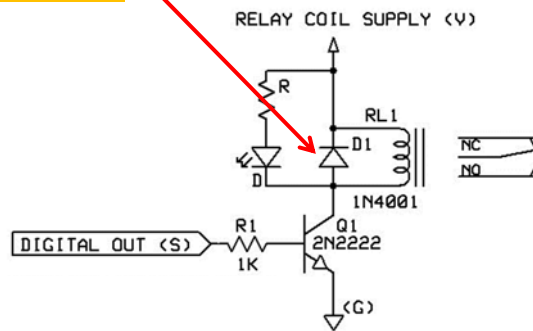


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Hardware Considerations Slide 26

## Bipolar Transistors & Relay

Flyback Diode;  
prevents voltage  
spike, if transistor  
is turned off



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Hardware Considerations Slide 27

## “Safe” Approach for Switching a 120 Vac Load

- Enclosed Power Relay (IoT Relay)
- Control voltage range: 3 – 48 V
- Load: 120 Vac and up to 12 A
- Price: ~ \$ 24
- Good approach for use in labs!



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Hardware Considerations Slide 28

## *Miscellaneous Topics*

## *Unconnected Pins*

If some pins are unused, it is recommended to ensure that these pins have a defined level.

Even though most of the digital inputs are disabled in "deep sleep" modes, floating inputs should be avoided to reduce current consumption in all other modes where the digital inputs are enabled (Reset, Active mode and Idle mode).

The simplest method to ensure a defined level of an unused pin is to enable the internal pull-up.

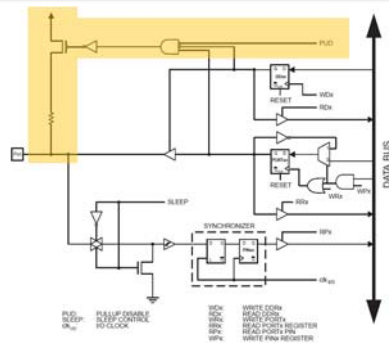
Connecting unused pins directly to VCC or GND is **not** recommended, since this may cause excessive currents if the pin is accidentally configured as an output.

## Pull-Ups Revisited

The Pull-up Disable – PUD bit in MCUCR disables the pull-up function for all pins in all ports when set.

If PORTxn is written logic one when the pin is configured as an input pin, the pull-up resistor is activated.

To switch the pull-up resistor off, PORTxn has to be written logic zero or the pin has to be configured as an output pin.



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Hardware Considerations Slide 31

## Pull-Ups Revisited

$T_A = -40^\circ\text{C}$  to  $85^\circ\text{C}$ ,  $V_{CC} = 1.8\text{V}$  to  $5.5\text{V}$  (unless otherwise noted) (Continued)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
$R_{RST}$	Reset Pull-up Resistor		30		60	$k\Omega$
$R_{PU}$	I/O Pin Pull-up Resistor		20		50	$k\Omega$
$V_{ACIO}$	Analog Comparator Input Offset Voltage	$V_{CC} = 5\text{V}$ $V_{in} = V_{CC}/2$		<10	40	mV
$I_{ACLK}$	Analog Comparator Input Leakage Current	$V_{CC} = 5\text{V}$ $V_{in} = V_{CC}/2$	-50		50	nA
$t_{ACID}$	Analog Comparator Propagation Delay	$V_{CC} = 2.7\text{V}$ $V_{CC} = 4.0\text{V}$		750 500		ns

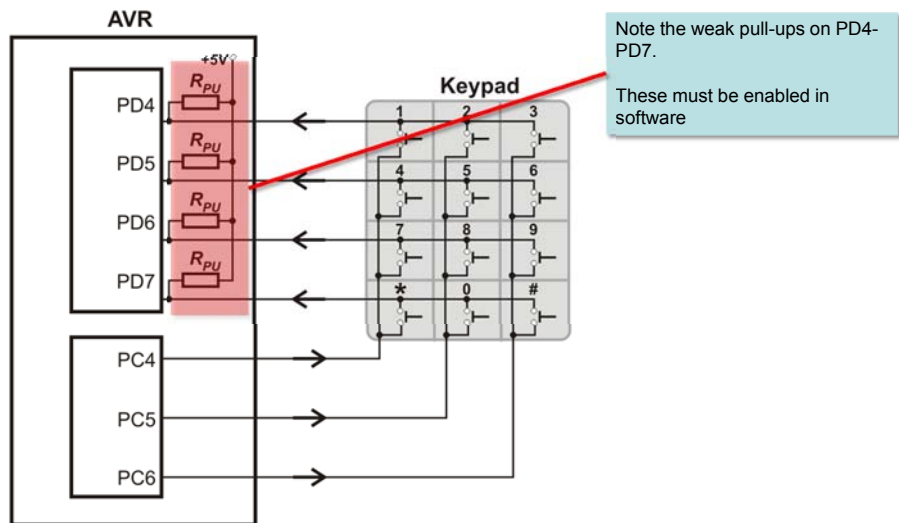
Pull-up resistors can have a significant spread between parts, and even individual pins on a port, so beware...

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Hardware Considerations Slide 32



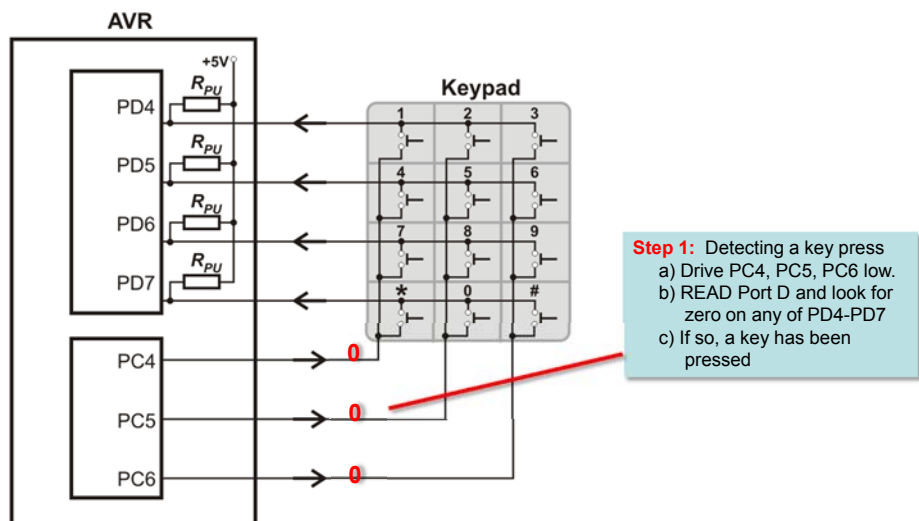
## Reading a Simple (3×4) Keypad



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Hardware Considerations Slide 33

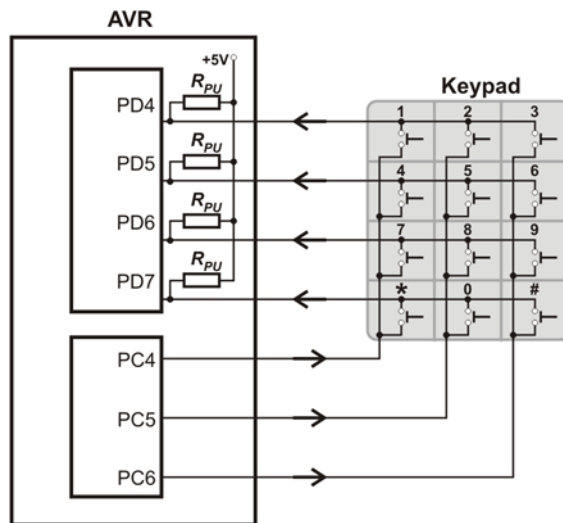
## Reading a Simple (3×4) Keypad



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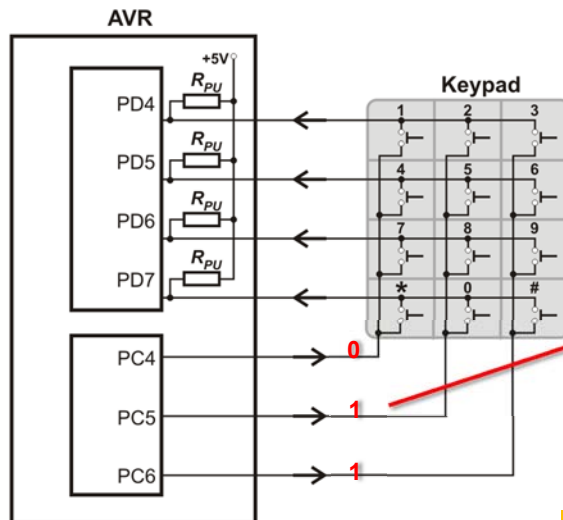
Hardware Considerations Slide 34

## Reading a Simple (3×4) Keypad



**Step 2:** Debounce. Wait an appropriate period for the key switch to stabilize (10 ms is probably a good waiting time)

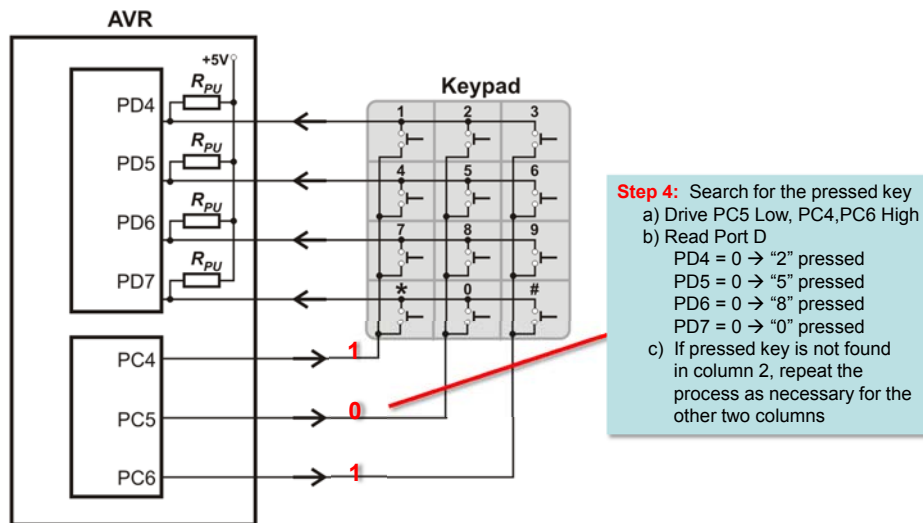
## Reading a Simple (3×4) Keypad



**Step 3:** Search for the pressed key  
a) Drive PC4 Low, PC5, PC6 High  
b) Read Port D  
PD4 = 0 → "1" pressed  
PD5 = 0 → "4" pressed  
PD6 = 0 → "7" pressed  
PD7 = 0 → "\*" pressed  
c) If pressed key is not found in column 1, repeat the process as necessary for the other two columns

Q: What could go wrong?

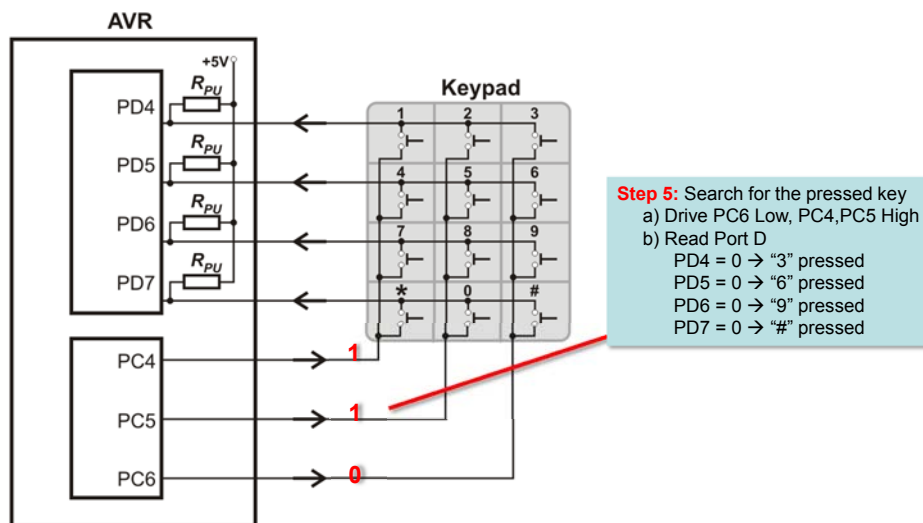
## Reading a Simple (3×4) Keypad



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Hardware Considerations Slide 37

## Reading a Simple (3×4) Keypad



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**... EOL**